

GaAs INTEGRATED CIRCUIT μPG2409TB

HIGH POWER SPDT SWITCH FOR WIMAX™

DESCRIPTION

The μ PG2409TB is a GaAs MMIC high power SPDT (<u>S</u>ingle <u>P</u>ole <u>D</u>ouble <u>T</u>hrow) switch which were designed for WiMAX.

This device can operate frequency from 0.5 to 3.8 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package (SC-88/SOT-363 type). And this package is suitable for high-density surface mounting.

FEATURES

Switch control voltage : V_{cont} (H) = 3.0 V TYP.

: V_{cont} (L) = 0 V TYP.

Low insertion loss
 Lins = 0.35 dB TYP. @ f = 1.0 GHz

: Lins = 0.45 dB TYP. @ f = 2.5 GHz : Lins = 0.50 dB TYP. @ f = 3.0 GHz : ISL = 32 dB TYP. @ f = 1.0 GHz

: ISL = 26 dB TYP. @ f = 2.5 GHz : ISL = 23 dB TYP. @ f = 3.0 GHz

• Handling power : $P_{in (1 dB)} = +35.0 dBm TYP$. @ f = 0.5 to 3.8 GHz

• High-density surface mounting : 6-pin super minimold package (SC-88/SOT-363 type) ($2.0 \times 1.25 \times 0.9$ mm)

APPLICATIONS

High isolation

• WiMAX and wireless LAN (IEEE802.11b/g/n)

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPG2409TB-E4	μPG2409TB-E4-A	6-pin super minimold (SC-88/SOT-363 type) (Pb-Free)	G5T	 Embossed tape 8 mm wide Pin 4, 5, 6 face the perforation side of the tape Qty 3 kpcs/reel

Remark To order evaluation samples, please contact your nearby sales office.

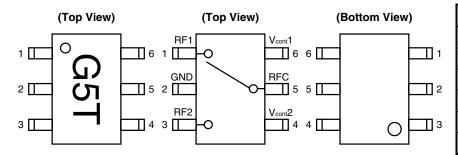
Part number for sample order: µPG2409TB

Caution Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

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PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name
1	RF1
2	GND
3	RF2
4	V _{cont} 2
5	RFC
6	V _{cont} 1

SW TRUTH TABLE

On Path	V _{cont} 1	V _{cont} 2	
RFC-RF1	High	Low	
RFC-RF2	Low	High	

ABSOLUTE MAXIMUM RATINGS (TA = +25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Switch Control Voltage		Vcont	+6.0 Note	V
Input Power	V _{cont} = 3 V	Pin	+35	dBm
	V _{cont} = 5 V	Pin	+37	
Power Dissipation	n (average)	Po	150	mW
Operating Ambient Temperature		TA	-45 to +85	°C
Storage Temper	ature	Tstg	-55 to +150	°C

Note $|V_{cont}1 - V_{cont}2| \le 6.0 \text{ V}$

RECOMMENDED OPERATING RANGE (TA = +25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Operating Frequency	f	0.5	ı	3.8	GHz
Switch Control Voltage (H)	V _{cont (H)}	2.7	3.0	5.3	٧
Switch Control Voltage (L)	V _{cont (L)}	-0.2	0	0.2	٧
Control Voltage Difference	$\Delta V_{cont (H)}$, $\Delta V_{cont (L)}^{Note}$	-0.1	0	0.1	V

Note $\Delta V_{cont (H)} = V_{cont} 1_{(H)} - V_{cont} 2_{(H)}$ $\Delta V_{cont (L)} = V_{cont} 1_{(L)} - V_{cont} 2_{(L)}$

ELECTRICAL CHARACTERISTICS

(TA = +25°C, $V_{cont}(H) = 3.0 \text{ V}$, $V_{cont}(L) = 0 \text{ V}$, $Z_{O} = 50 \Omega$, DC blocking capacitors = 8 pF, unless otherwise specified)

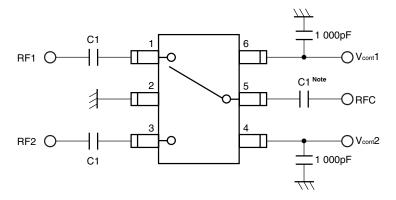
Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss 1	Lins1	f = 0.5 to 1.0 GHz ^{Note 1}	-	0.35	0.60	dB
Insertion Loss 2	Lins2	f = 1.0 to 2.0 GHz ^{Note 1}	-	0.40	0.65	dB
Insertion Loss 3	Lins3	f = 2.0 to 2.5 GHz	-	0.45	0.70	dB
Insertion Loss 4	Lins4	f = 2.5 to 3.0 GHz	-	0.50	0.75	dB
Insertion Loss 5	Lins5	f = 3.0 to 3.8 GHz	-	0.60	0.85	dB
Isolation 1	ISL1	f = 0.5 to 1.0 GHz ^{Note 1}	29	32	-	dB
Isolation 2	ISL2	f = 1.0 to 2.0 GHz ^{Note 1}	25	28	-	dB
Isolation 3	ISL3	f = 2.0 to 2.5 GHz	23	26	-	dB
Isolation 4	ISL4	f = 2.5 to 3.0 GHz	20	23	-	dB
Isolation 5	ISL5	f = 3.0 to 3.8 GHz	16	19	-	dB
Return Loss	RL	f = 0.5 to 3.8 GHz ^{Note 1}	15	20	-	dB
0.1 dB Loss Compression Input Power Note 2	Pin (0.1 dB)	f = 2.5 GHz	-	+33.5	-	dBm
1 dB Loss Compression Input Power 1 Note 3	Pin (1 dB) 1	f = 0.5 to 3.8 GHz ^{Note 1} V _{cont} = 3 V	_	+35	_	dBm
1 dB Loss Compression Input Power 2 Note 3	Pin (1 dB) 2	$f = 0.5 \text{ to } 3.8 \text{ GHz}^{\text{Note 1}}$ $V_{\text{cont}} = 5 \text{ V}$	-	+37	-	dBm
2nd Harmonics	2fo	f = 2.5 GHz, Pin = +26 dBm	-	75	-	dBc
3rd Harmonics	3fo	f = 2.5 GHz, Pin = +26 dBm	-	80	-	dBc
Input 3rd Order Intercept Point	IIРз	f = 2.5 GHz	-	+60	-	dBm
Switch Control Current	Icont	No RF input	-	0.1	10	μΑ
Switch Control Speed	tsw	50% CTL to 90/10% RF	-	100	250	ns

Notes 1. DC blocking capacitors = 56 pF at f = 0.5 to 2.0 GHz

- 2. Pin (0.1 dB) is the measured input power level when the insertion loss increases 0.1 dB more than that of the linear range.
- **3.** Pin (1 dB) is the measured input power level when the insertion loss increases 1 dB more than that of the linear range.

Caution It is necessary to use DC blocking capacitors with this device.

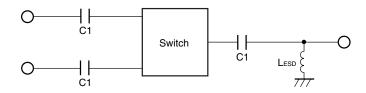
EVALUATION CIRCUIT



Note C1 : 0.5 to 2.0 GHz 56 pF : 2.0 to 3.8 GHz 8 pF

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

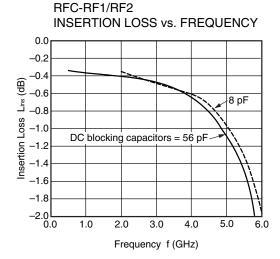
APPLICATION INFORMATION

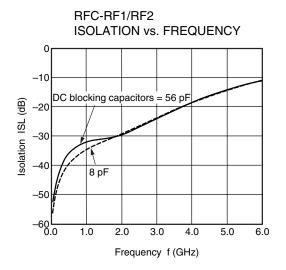


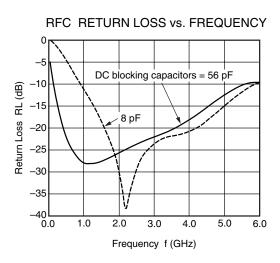
- C1 are DC blocking capacitors external to the device.
 The value may be tailored to provide specific electrical responses.
- The RF ground connections should be kept as short as possible and connected to directly to a good RF ground for best performance.
- Lesp provides a means to increase the ESD protection on a specific RF port, typically the port attached to the antenna.

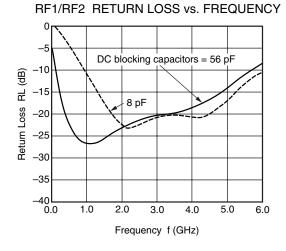
TYPICAL CHARACTERISTICS

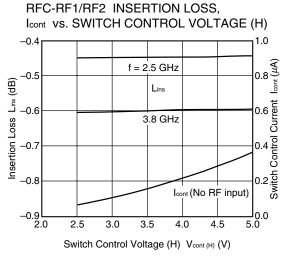
(TA = +25°C, V_{cont} (H) = 2.7 to 5.3 V, V_{cont} (L) = -0.2 to 0.2V, unless otherwise specified)

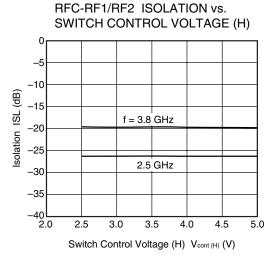








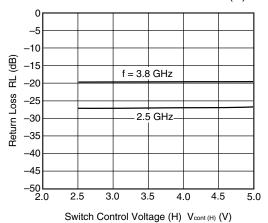




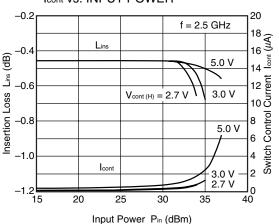
Remark The graphs indicate nominal characteristics.

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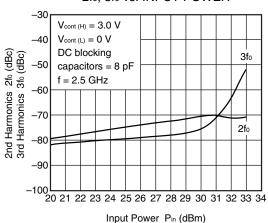
RFC RETURN LOSS vs. SWITCH CONTROL VOLTAGE (H)



RFC-RF1/RF2 INSERTION LOSS, Icont vs. INPUT POWER

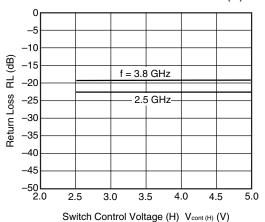


RFC-RF1/RF2 2fo, 3fo vs. INPUT POWER

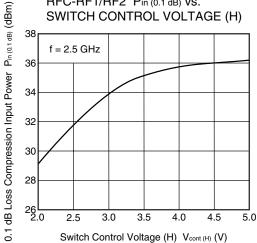


Remark The graphs indicate nominal characteristics.

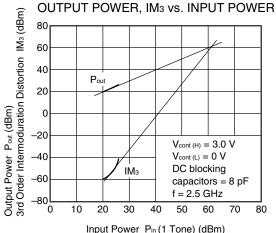
RF1/RF2 RETURN LOSS vs. SWITCH CONTROL VOLTAGE (H)



RFC-RF1/RF2 Pin (0.1 dB) vs.



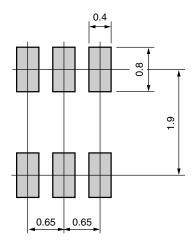
RFC-RF1/RF2



Input Power Pin (1 Tone) (dBm)

MOUNTING PAD LAYOUT DIMENSIONS

6-PIN SUPER MINIMOLD (SC-88/SOT-363 type) (UNIT: mm)

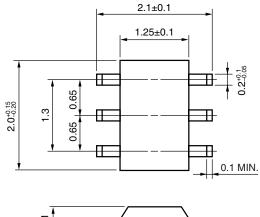


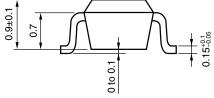
Remark The mounting pad layout in this document is for reference only.

When designing PCB, please consider workability of mounting, solder joint reliability, prevention of solder bridge and so on, in order to optimize the design.

PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (SC-88/SOT-363 type) (UNIT: mm)





RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions	Condition Symbol	
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (terminal temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

NEC μ PG2409TB

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GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
- Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.